

ABSTRACT OF THE DISCLOSURE

A pallet 1 for holding an FPC 9 in order to mount electronic components thereon includes a first adhesive holding region 21 in a peripheral portion and a second adhesive holding region 22 in a central portion. The first adhesive holding region 21 has a relatively low tackiness, whereas the second adhesive holding region 22 has a higher tackiness than that of the first adhesive holding region 21. The pallet 1 has through holes 31 for receiving push-up pins to be used when peeling off the FPC 9, and air outlets 32 for assisting in the peeling.